

Low-Voltage Standard Telephone Circuit

Description

TEMIC Semiconductors' low-voltage telephone circuit, U3760MB-N, performs all the speech and line interface functions required in an electronic telephone set tone ringer, pulse and DTMF dialing with redial.

Electrostatic sensitive device.
Observe precautions for handling.



Features

Speech Circuit

- Adjustable dc characteristic
- Symmetrical input of microphone amplifier
- Receiving amplifier for dynamic or piezo-electric earpieces
- Automatic line-loss compensation

- Selectable flashing duration by key pad
- Pause function
- Last number redial up to 32 digits
- Standard low-cost crystal 3.58 MHz or ceramic resonator

Dialer

- DTMF / pulse switchable
- Pulse dialing 66/33 or 60/40 for 10 ppS and 20 ppS or DTMF dialing selectable by pins
- Key tone
- Handset Mute (Privacy) with optical indication

Tone Ringer

- Two-tone ringer
- Adjustable volume
- RC oscillator
- Adjustable threshold

Benefits

- Low number of external components
- High quality through one IC solution
- One IC for all standards

Ordering Information

Extended Type Number	Package	Remarks
U3760MB-NFN	SSO44	Tube
U3760MB-NFNG3	SSO44	Taped and reeled

Block Diagram / Applications

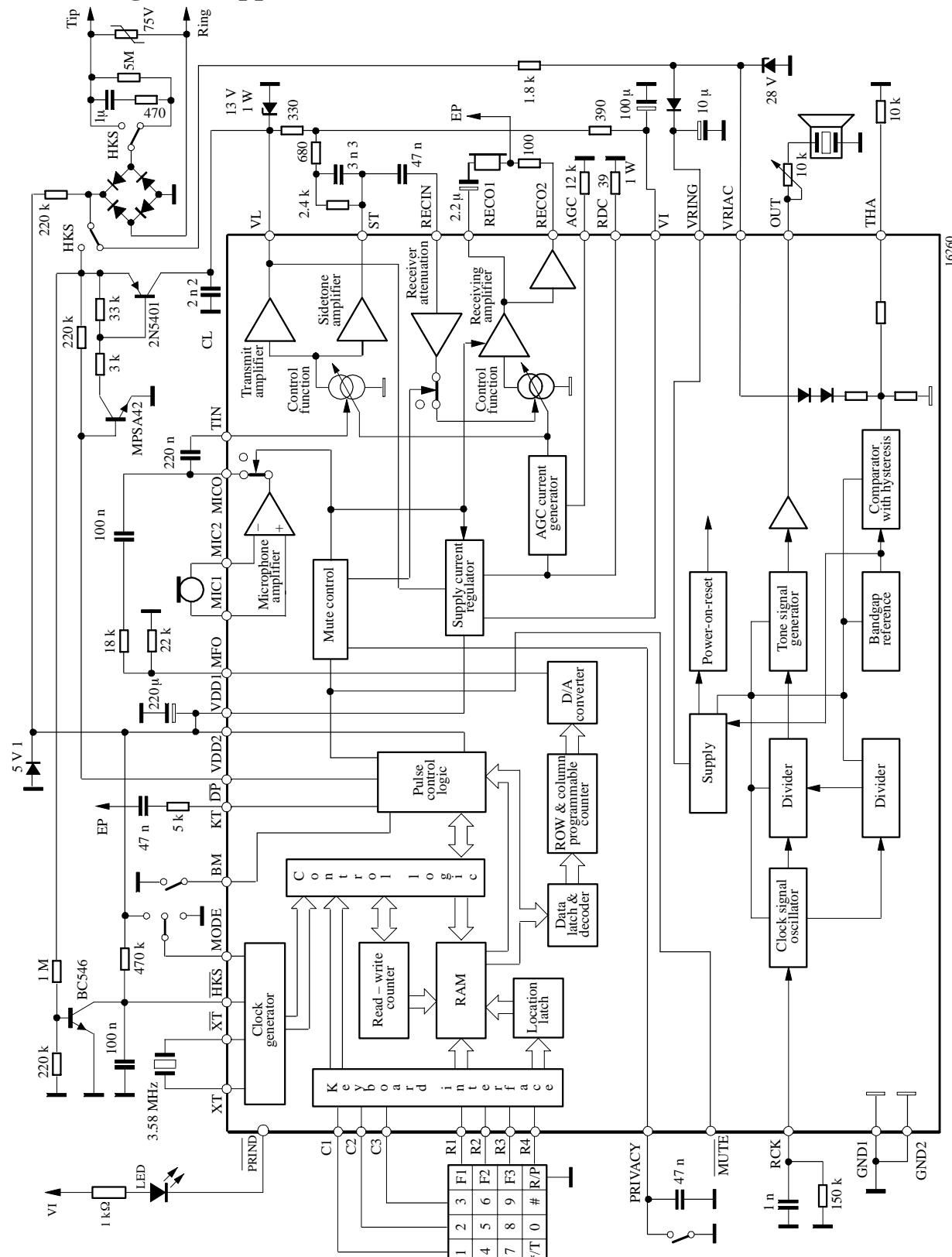
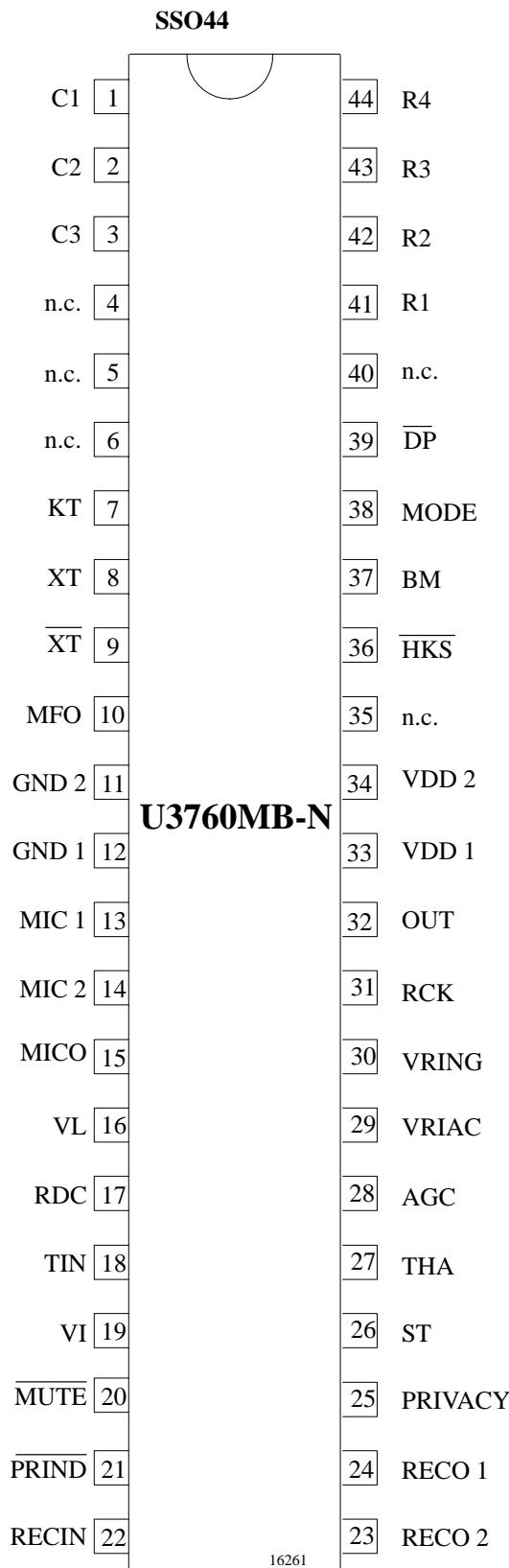


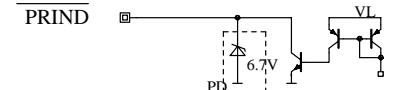
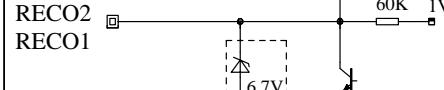
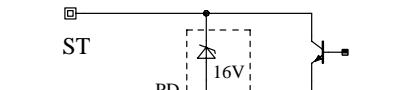
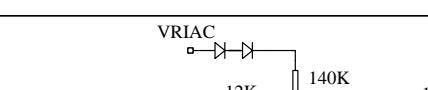
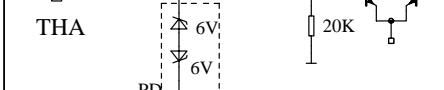
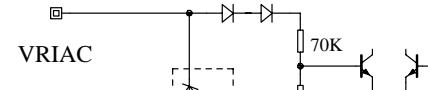
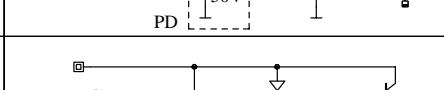
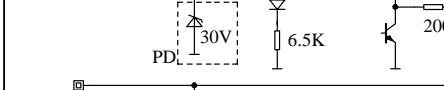
Figure 1.



Pin Description

SSO44	Symbol	Function	Configuration
1	C1	Keyboard input	
2	C2		
3	C3		
4, 5, 6, 35	NC	Not connected	
7	KT	Key tone signal output generated for all keys in pulse dialing mode (except Flash + Redial) with a frequency of about 1240 Hz and duration about 50 ms	
8	XT	A built-in inverter provides oscillation with an inexpensive 3.579545 MHz crystal or ceramic resonator	
9	XT		
10	MFO	Output of DTMF	
12	GND 1	Ground 1 connected with ground 2	
11	GND 2		

SSO44	Symbol	Function	Configuration
13	MIC 1	Inverting input of microphone amplifier	
14	MIC 2	Non-inverting input of microphone amplifier	
15	MICO	Transmit pre-amp output which is normally capacitively coupled to Pin TIN	
16	VL	Positive supply voltage input to the device. The current through this pin is modulated by the transmit signal.	
17	RDC	An external resistor (1 W) is required from this pin to GND to control the dc input impedance of the circuit. It has a nominal value of $39\ \Omega$ for low-voltage operation. Values up to $100\ \Omega$ may be used to increase the available transmit output voltage swing at the expense of low-voltage operation.	
18	TIN	Input to the line output driver amplifier. Transmit AGC applied to this stage.	
19	V _I	This internal voltage bias line must be connected to VL via an external resistor, R_B , which dominates the ac input impedance of the circuit and should be $680\ \Omega$ for an $600\ \Omega$ input impedance or $1.2\ k\Omega$ for a $900\ \Omega$ input impedance.	
20	MUTE	Pin for testing	

SSO44	Symbol	Function	Configuration
21	PRIND	PRIVACY indication pin Open collector with minimum 1 mA drive current to GND when PRIVACY = active	
22	RECIN	Receive amplifier input. The receiving amplification is regulated by an AGC.	
24	RECO1	Output of the receive amplifier. Dynamic transducers with a minimum impedance of 100 Ω can be directly driven by these outputs.	
23	RECO2	Output of the receive amplifier. Dynamic transducers with a minimum impedance of 100 Ω can be directly driven by these outputs.	
25	PRIVACY		
26	ST	The output of the sidetone cancellation signal, which requires a balanced impedance of 8 to 10 times the subscribers line impedance to be connected to Pin VL.	
27	THA	Ringer threshold adjustment	
28	AGC	The range of transmit and receive gain variations between short and long loops may be adjusted by connecting a resistor R _{AGC} from this pin to (GND). This pin can be left open to set AGC out of action.	
29	VRIAC	Ringing supply	
30	VRING	DC supply voltage for the tone ringer is limited to 30 V with integrated Z-diode.	
	OUT		

SSO44	Symbol	Function	Configuration
31	RCK	RC clock oscillator for ringer	
32	OUT	Buzzer output	
33	VDD 1	Supply output for dialer part	
34	VDD 2	Supply input of dialer section	
36	\overline{HKS}	<p>Hook switch input. $\overline{HKS} = 1$: On-hook state. Chip in sleep mode, no operation. $\overline{HKS} = 0$: Off-hook state. Chip enable for normal operation.</p>	
37	BM	<p>If BM = floating pulse dialing with 3:2 B/M ratio If BM is connected to ground pulse dialing with a B/M ratio of 2:1</p>	
38	MODE	Pulling mode pin to VDD places the dialer in tone mode. Pulling mode pin to GND places the dialer in pulse mode (20 ppS). If the mode pin is left floating, the dialer is in pulse mode (10 ppS)	
39	\overline{DP}	N-channel open drain pulse dialing output. Flash key will cause \overline{DP} to be active in either DTMF mode or pulse mode.	

SSO44	Symbol	Function	Configuration
41	R1	Keyboard input	R1
42	R2		R2
43	R3		R3
44	R4		R4

Keyboard Operation

C1	C2	C3	
1	2	3	F1
4	5	6	F2
7	8	9	F3
*/T	0	#	R/P
			—

- */T: * and pulse-to-tone key
- R/P: Redial and pause function key
- F1, F2, F3: Flash keys

Normal Dialing

[OFF HOOK] , [D1] , [D2] , ..., [Dn]

1. D1, D2, ..., Dn will be dialed out.
2. Dialing length is unlimited, but redial is inhibited if length oversteps 32 digits.

Redialing

[OFF HOOK] , [D1] , [D2] , ..., [Dn] BUSY, Come [ON HOOK] , [OFF HOOK] , [R/P]

The [R/P] key can execute the redial function only as the first key-in after off-hook; otherwise, it executes the pause function.

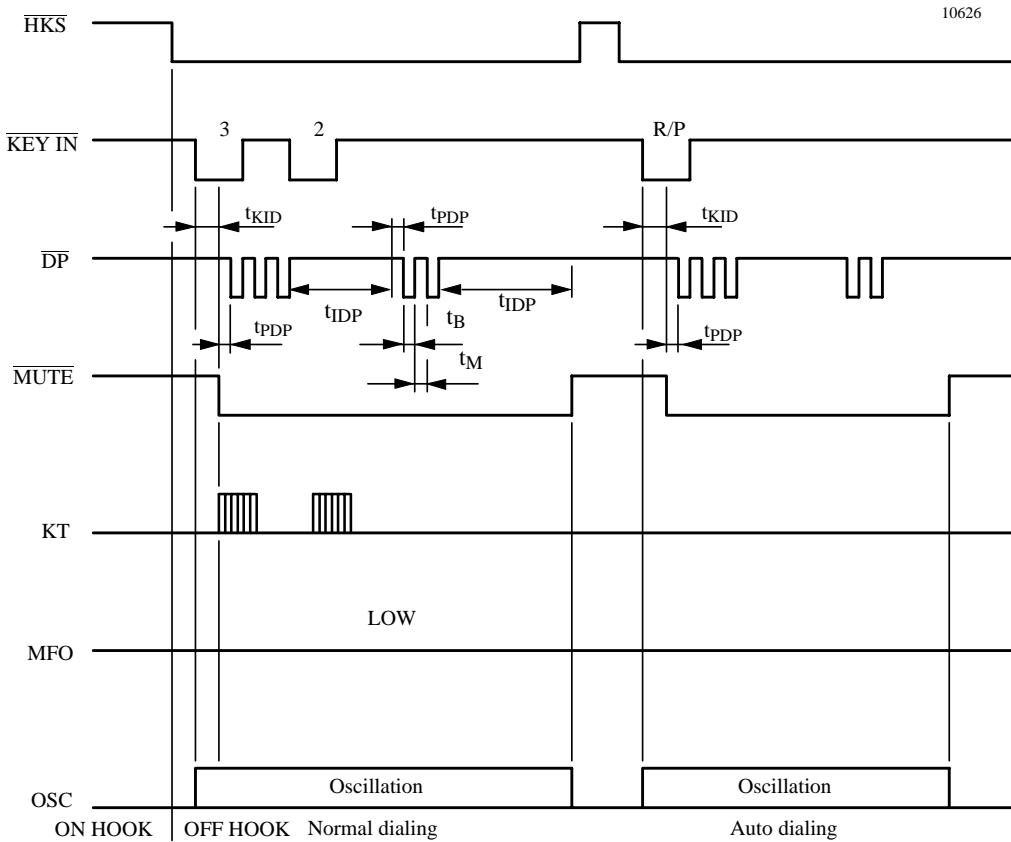


Figure 2. Pulse mode

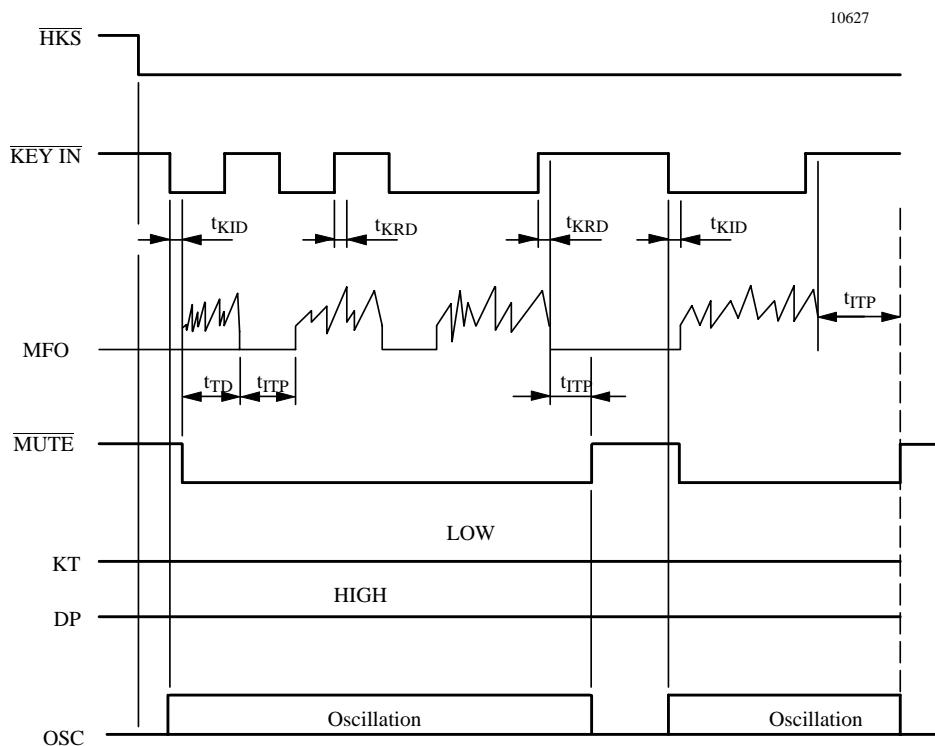


Figure 3. DTMF mode normal dialing

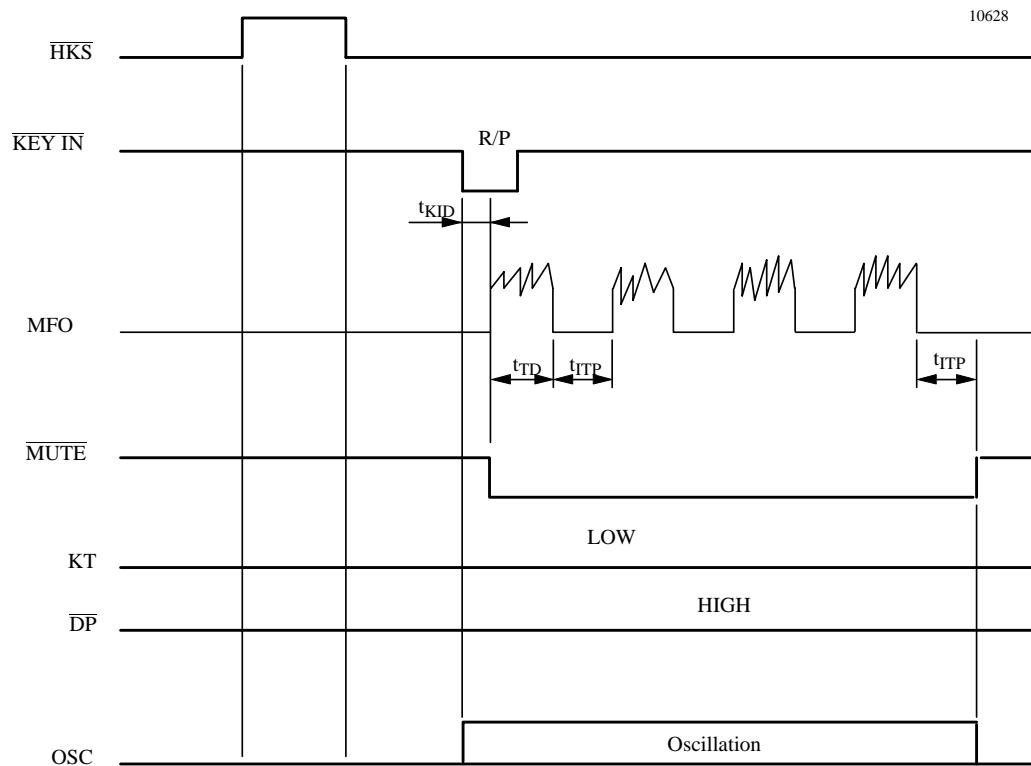


Figure 4. DTMF auto dialing

Access Pause

OFF HOOK , **D1** , **D2** , **R/P** , **D3** , ..., **Dn'**

1. The pause function can be stored in memory.
2. The pause function is executed in normal dialing and redialing.

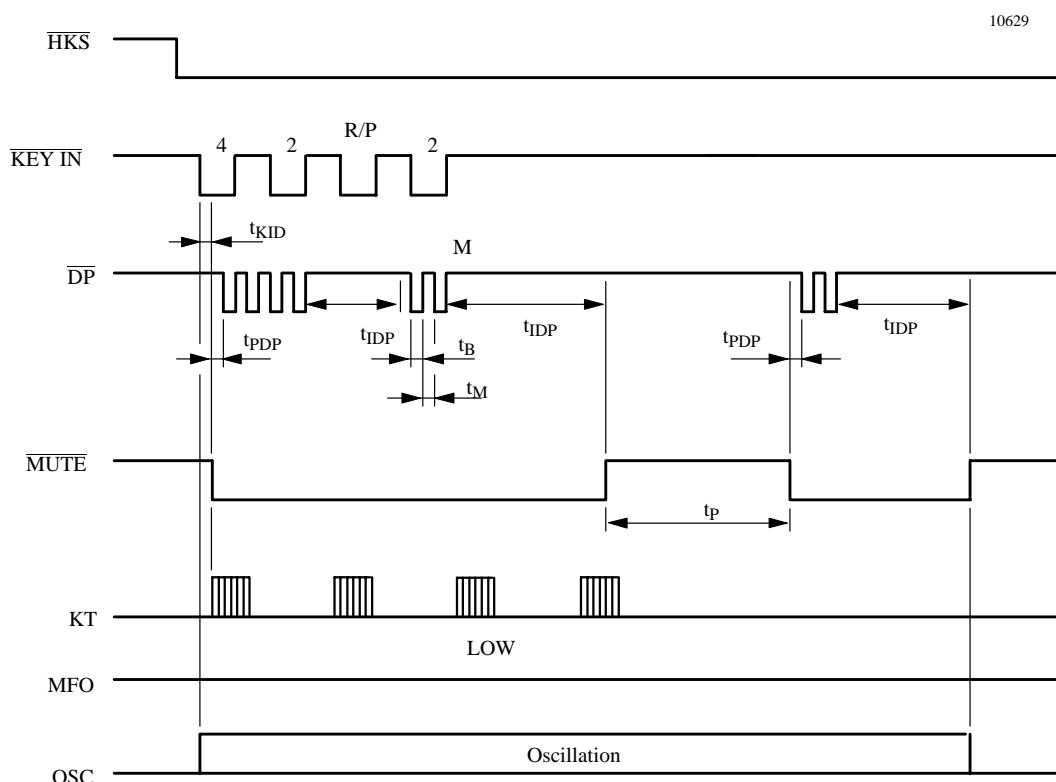


Figure 5. Pause function

Pulse-to-Tone ($*/T$)

OFF HOOK , [D1] , [D2] , ..., [Dn] , $*/T$, [D1'] , [D2'] , ..., [Dn']

- If the mode switch is set to pulse mode, then the output signal will be:

D1, D2, ..., Dn, Pause (3.6 s), D1', D2', ..., Dn'

(Pulse) (Tone)

- If the mode switch is set to tone mode, then the output signal will be:

D1, D2, ..., Dn, * , D1', D2', ..., Dn'

(Tone) (Tone) (Tone)

- The dialer remains in tone mode when the digits have been dialed out and can be reset to pulse mode only by going on-hook.

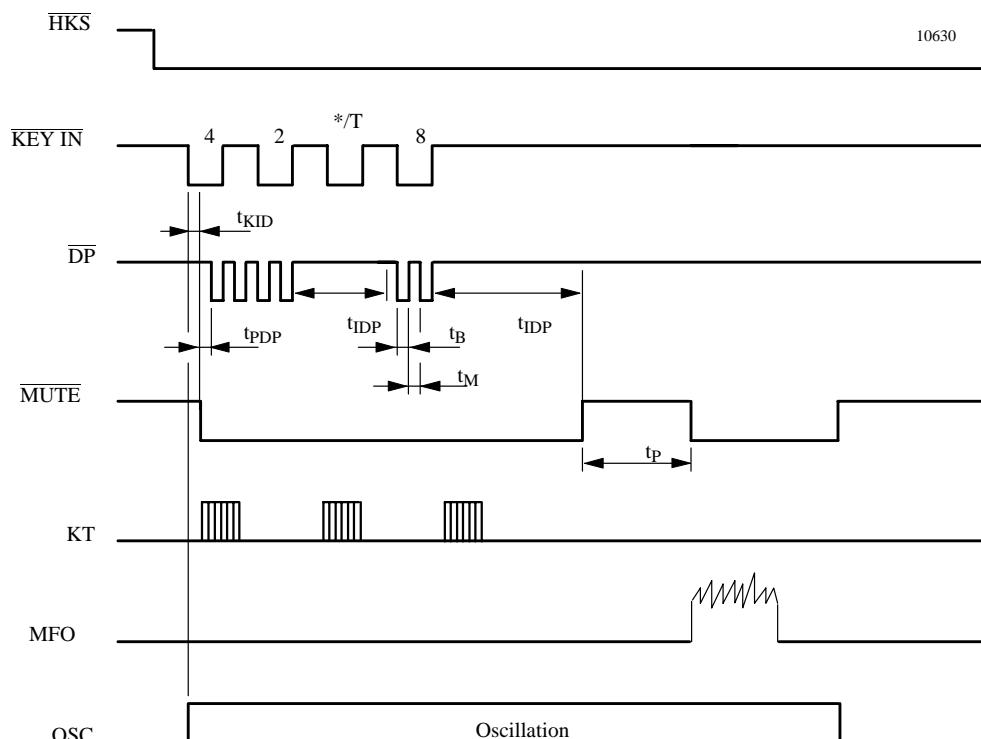


Figure 6. Pulse-to-tone operation

Flash (F1 or F2 or F3)**[OFF HOOK] , [Fn]**

1. The flash key cannot be stored as a digit in memory. The flash key has first priority among the keyboard functions.
2. The system will return to the initial state after the flash pause time is finished.

[OFF HOOK] , [Fn] , [D1] , [D2] , [D3] , ..., [Dn]

LNB = D1, D2, D3, ..., Dn

[OFF HOOK] , [D1] , [D2] , [Fn] , [D3] , ..., [Dn]

LNB = D3, ..., Dn

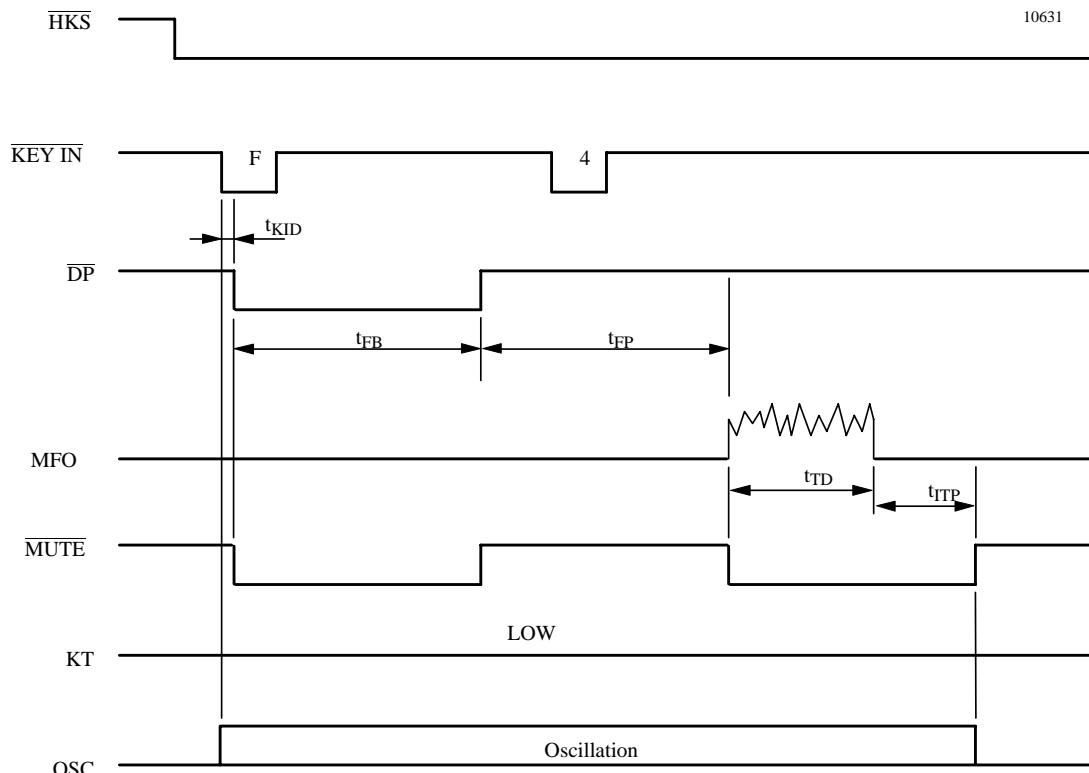
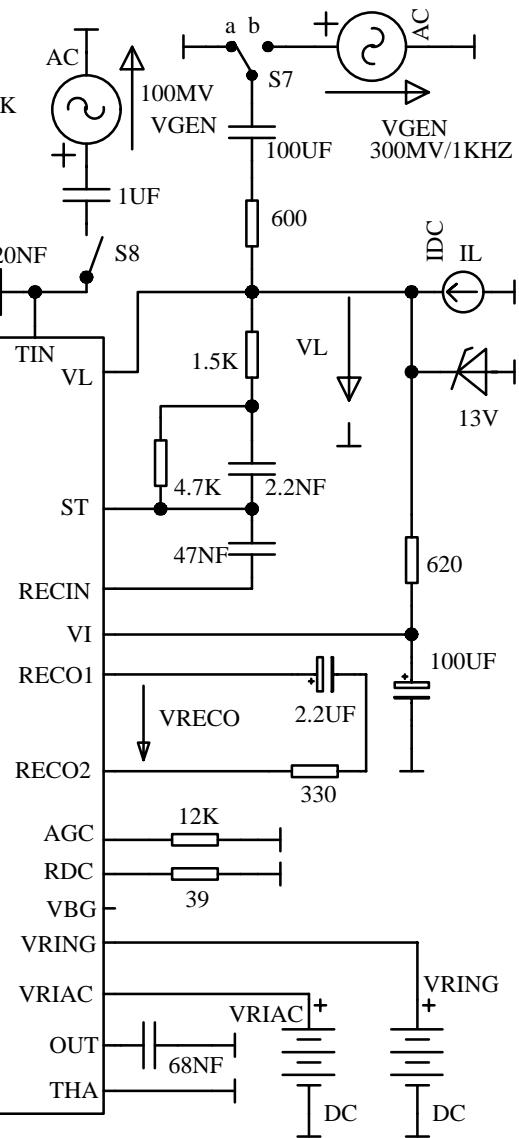


Figure 7. Flash operation

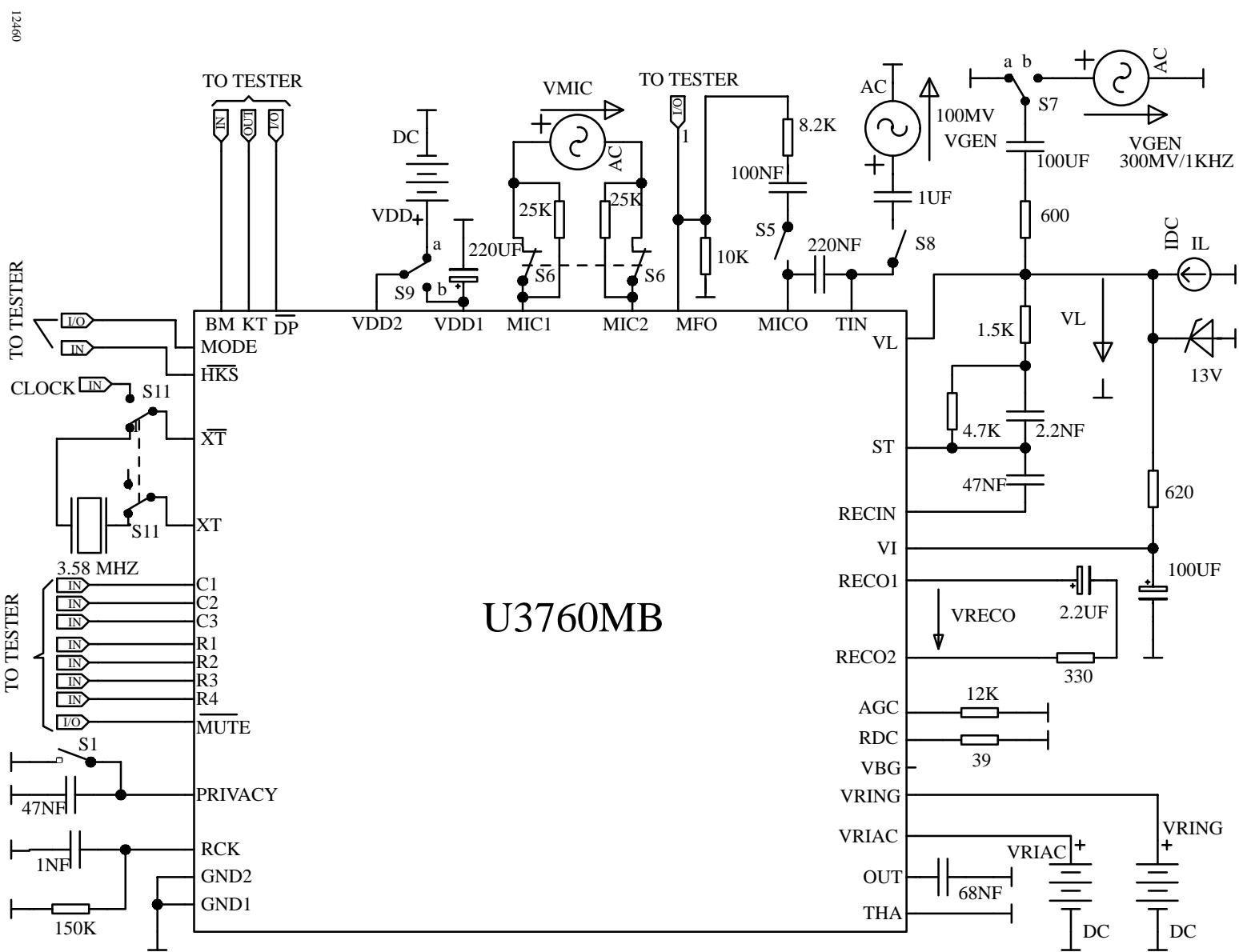
t_{KID} = key active in debounce
 t_{KRD} = key release debounce
 t_{PDP} = pre-digit pause
 t_{IDP} = inter-digit pause
 t_{TD} = DTMF output duration

t_{ITP} = intertone pause
 t_{FB} = flash break time
 t_{FP} = flash pause time
 t_P = pause time

Basic Test Circuit



U3760MB



Formulas for Parameters of Electrical Characteristics of Speech Circuit

Formulas referred to the basic test circuit. If not otherwise specified switches in basic test circuit are inactive.

Transmit gain

$$GS = 20 \times \log \left(\frac{VL}{VMIC} \right)$$

VMIC = 3 mV/1 kHz, S5 = open

Receiving gain

$$GR = 20 \times \log \left(\frac{VRECO}{VL} \right)$$

RX-mode: VGEN = 300 mV/1 kHz, S7b

Line loss compensation transmit

$\Delta GS = GS(\text{at } IL = 73 \text{ mA}) - GS(\text{at } IL = 20 \text{ mA})$

TX-mode: VMIC = 3 mV/1 kHz, S5 = open

Sidetone reduction

$$GSTA = 20 \times \log \left(\frac{VL}{VRECO} \right) \text{(in TX-mode)} + GR$$

TX-mode: VMIC = 3 mV/1 kHz, S5 = open

Line loss compensation receive

$\Delta GR = GR(\text{at } IL = 73 \text{ mA}) - GR(\text{at } IL = 20 \text{ mA})$

RX-mode: VGEN = 300 mV/1 kHz, S7b

Gain change when muted

$$GRM = 20 \times \log \frac{VRECO}{VL} \text{ (Mute = inactive)} - 20 \times \log \frac{VRECO}{VL} \text{ (Mute = active)}$$

VGEN = 100 mV/1 kHz, S5 = open, S8 = open

Input impedance of microphone amplifier

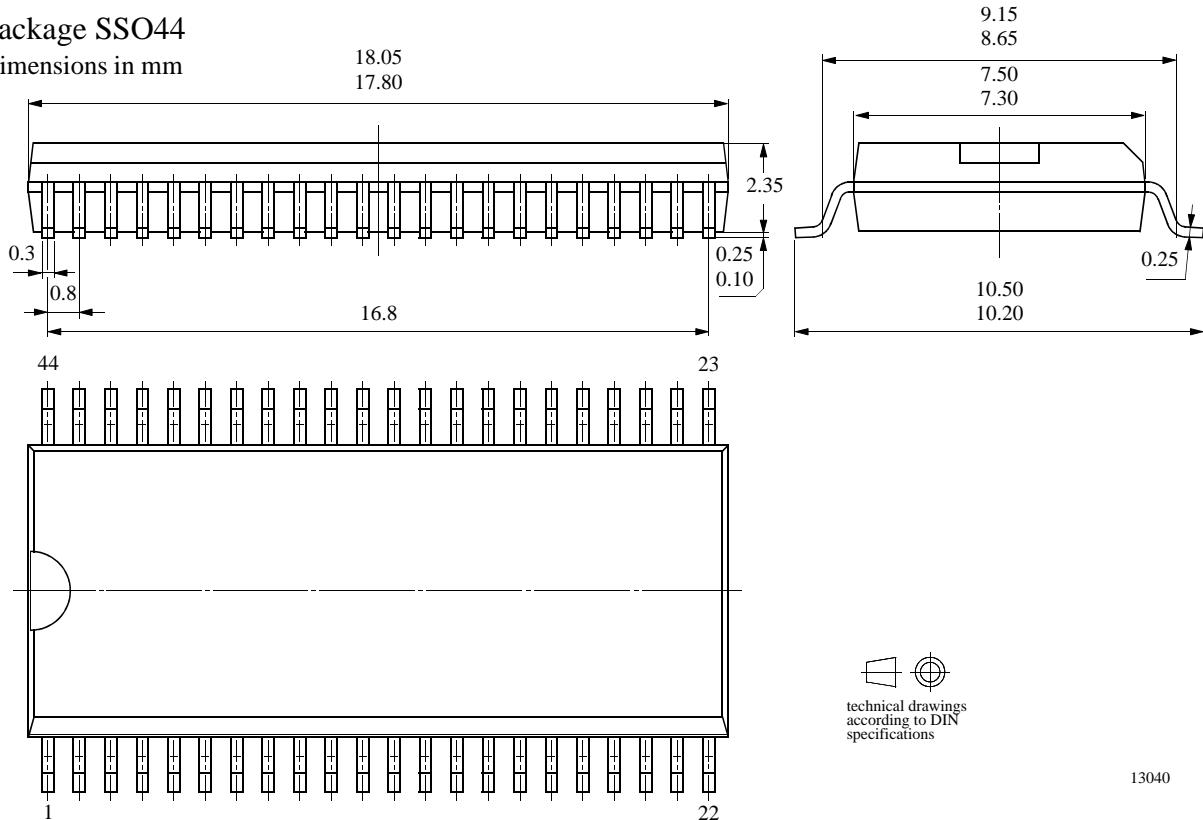
$$R_i = \frac{50 \text{ k}}{\left(\frac{VL_{(S6 = \text{closed})}}{VL_{(S6 = \text{open})}} - 1 \right)}$$

TX-mode: VMIC = 3 mV/1 kHz, S5 = open

Package Information

Package SSO44

Dimensions in mm



technical drawings
according to DIN specifications

13040

Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify TEMIC Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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